TOSHIBA

TLP191B

TOSHIBA Photocoupler IRED & Photo-Diode Array

TLP191B

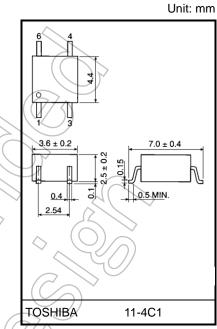
Telecommunication Programmable Controllers MOS Gate Driver MOS FET Gate Driver

The TOSHIBA mini-flat coupler TLP191B is a small outline coupler, suitable for surface mount assembly.

The TLP191B consists of an infrared emitting diode, optically coupled to a series connected photo diode array with shunt resistor which is suitable for MOS FET gate drive.

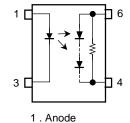
TLP191B : Mini Flat Package, 4Pin, one circuit

- Open voltage: 7.0 V (min)
- Short current: 24 μA (min)
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349



Weight: 0.09 g (typ.)

Pin Configuration (top view)



3 . Cathode

4 . Cathode

6. Anode

Start of commercial production 1990-11

Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit	
	Forward current	١ _F	50	mA	
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C	\sim
	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	А	
LED	Reverse voltage	VR	3	V	
	Diode power dissipation	PD	100	mW	\square
	Diode power dissipation derating (Ta >25°C)	$\Delta P_D / C$	-1.0	mW/°C	
	Junction temperature	Тj	125	°C	
	Forward current	IFD	50	μΑ	
Detector	Reverse voltage	V _{RD}	10	N	
Delector	Output power dissipation	PO	0.5	Wm	\searrow
	Junction temperature	Тj	125	<u>с</u>	
Storage temperature range		T _{stg}	-55 to 125	°°	\diamond
Operating	temperature range	T _{opr}	-40 to 85	°C	
Lead soldering temperature (10 s)		T _{sol}	260	°C	(C
Isolation vo (AC, 60 s,	oltage R.H. ≤ 60 %) (Note 1)	BVs	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Forward current	lF	_	20	25	mA
Operating temperature	T _{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I _R	V _R = 3 V	—		10	μA
	Capacitance between terminals	Ст	V = 0 V, f = 1 MHz	- 2	30	60	pF
Detector	Forward voltage	V _{FD}	I _{FD} = 10 μA	. L C		_	V
	Reverse current	IRD	V _{RD} = 10 V	\swarrow	~(7/	_	μA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol Test Condition	MIn	Тур.	Max	Unit
Open voltage	V _{OC} I _F = 20 mA	7	8	_	V
Short current	lsc IF = 20 mA	24	40	—	μA

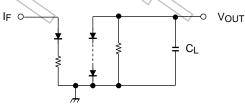
Isolation Characteristics (Ta = 25°C)

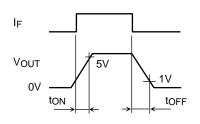
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	2500			Vrms

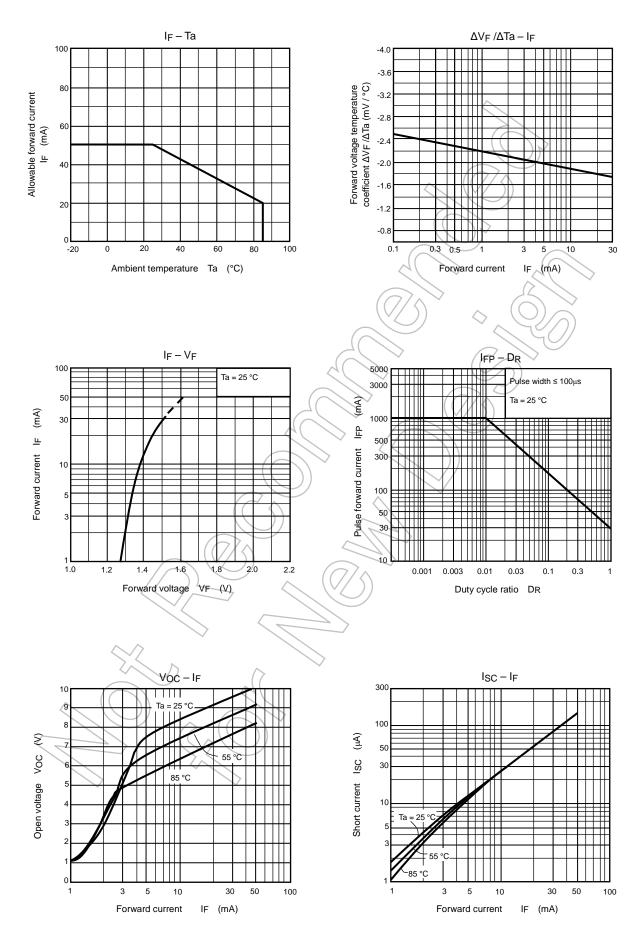
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	✓ Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	IF = 20 mA, CL = 1000 pF	—	0.2	_	
Turn-off time	tOFF	(Note1)		3		ms

Note 1: Switching time test circuit







NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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